## DATA SHEET

 GITI-SULFURATED GIIP RESSSTORS AF 122 (4Pin/2R) / AF124 (8Pin/4R) / AF162 (4Pin/ 2R)/ AF164 (8Pin/ 4R)
## SCOPE

This specification describes AFI22/AFI24/AFI62/AFI64 (convex)series chip resistor arrays with lead-free terminations made by thick film process.

## APPLICATIONS

- Terminal for SDRAM and DDRAM
- High-end Computer \& Multimedia Electronics in high sulfur environment
- Consume electronic equipments: PDAs, PNDs
- Mobile phone, telecom...


## FEATURES

- AEC-Q200 qualified
- RoHS compliant
- Reducing environmentally hazardous wastes
- High component and equipment reliability
- Saving of PCB space
- None forbidden-materials used in products/production
- Halogen Free Epoxy
- Moisture sensitivity level: MSL I


## ORDERJNG INFORMATION - GLOBAL PART NUMBER \& I2NS

Both part numbers are identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

## YAGEO BRAND ordering code

## GLOBAL PART NUMBER (PREFERRED)

## AF XX X - X X XX XXXX L

(1) (2) (3) (4) (5) (6) (7)
(I) SIZE
$12=0402 \times 2(0404)$
$12=0402 \times 4(0408)$
$16=0603 \times 2(0606)$
$16=0603 \times 4$ (06I2)
(2) NUMBER OF RESISTORS
$2=2$ resistors
$4=4$ resistors
(3) TOLERANCE
$F= \pm 1 \%$
$J= \pm 5 \%$ (for Jumper ordering, use code of J)
(4) PACKAGING TYPE
$R=$ Paper taping reel
(5) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec
(6) TAPING REEL
$07=7$ inch dia. Reel
$13=13$ inch dia. Reel
(7) RESISTANCE VALUE

There are $2 \sim 4$ digits indicated the resistor value. Letter R/K/M is decimal point, no need to mention the last zero after R/K/M, e.g. I K2, not I K20.

Detailed resistance rules show in table of "Resistance rule of global part number".

Resistance rule of global part number

| Resistance code rule | Example |
| :---: | :---: |
| OR | OR = jumper |
| $\begin{aligned} & \text { XRXX } \\ & \text { (I to } 9.76 \Omega \text { ) } \end{aligned}$ | $\begin{array}{r} \mathrm{IR}=1 \Omega \\ \text { IR5 }=1.5 \Omega \\ 9 \mathrm{R} 76=9.76 \Omega \end{array}$ |
| $\begin{aligned} & \text { XXRX } \\ & (10 \text { to } 97.6 \Omega) \end{aligned}$ | $\begin{array}{r} 10 R=10 \Omega \\ 97 R 6=97.6 \Omega \end{array}$ |
| $\begin{aligned} & \text { XXXR } \\ & (100 \text { to } 976 \Omega) \end{aligned}$ | $100 \mathrm{R}=100 \Omega$ |
| $\begin{aligned} & \hline X K X X \\ & (I \text { to } 9.76 \mathrm{~K} \Omega) \end{aligned}$ | $\begin{array}{r} 1 \mathrm{~K}=1,000 \Omega \\ 9 \mathrm{~K} 76=9760 \Omega \end{array}$ |
| $\begin{aligned} & \text { XM } \\ & (\mid M \Omega) \end{aligned}$ | $1 \mathrm{M}=1,000,000 \Omega$ |

## Ordering example

The ordering code of a AFI 22 convex chip resistor array, value l, $000 \Omega$ with $\pm 5 \%$ tolerance, supplied in 7 -inch tape reel is: AFI22-JR-07IKL.

## NOTE

I. All our R-Chip products meet RoHS compliant. "LFP" of the internal 2D reel label mentions "Lead Free Process"
2. On customized label, "LFP" or specific symbol printed and the optional "L" at the end of GLOBAL PART NUMBER

No marking

## AFI24 / AFI62 / AFI64

## ]

I-Digit marking
Fig. 2 Value $=0 \Omega$

## 316]

I\% E-24/E-96: $\mathrm{R} \geqq 100 \Omega$ 4digits
First three digits for significant figure and 4th digit for number of zeros
Fig. 3 Value $=316 \mathrm{~K} \Omega$

## Е44

Fig. 3 Value $=240 \mathrm{~K} \Omega$
$5 \% \mathrm{E}-24: \mathrm{R} \geqq 10 \Omega$
First two digits for significant figure and 3rd digit for number of zeros

For further marking information, please refer to data sheet "Chip resistors marking".

## CONSTRUCTION

The resistor is constructed on top of a high-grade ceramic body. Internal metal electrodes are added on each end to make the contacts to the thick film resistive element. The composition of the resistive element is a noble metal embedded into a glass and covered by a glass. The resistor is laser trimmed to the rated resistance value. The resistor is covered with a protective epoxy coat, finally the external terminations (matte tin on Nibarrier) are added as shown in Fig.4.

## OUTLINES



Fig. 4 Chip resistor outlines

## DJMENSIONS

Table I

| TYPE | AFI22 | AFI24 | AFI62 | AFI64 |
| :--- | ---: | ---: | ---: | ---: |
| B (mm) | $0.24 \pm 0.10$ | $0.25 \pm 0.15$ | $0.35 \pm 0.10$ | $0.35 \pm 0.15$ |
| H (mm) | $0.30+0.10 /-0.05$ | $0.45 \pm 0.05$ | $0.30 \pm 0.10$ | $0.65 \pm 0.05$ |
| $\mathrm{H}_{1}(\mathrm{~mm})$ | --- | $0.30 \pm 0.05$ | -- | $0.50 \pm 0.15$ |
| P (mm) | $0.67 \pm 0.05$ | $0.50 \pm 0.05$ | $0.80 \pm 0.05$ | $0.80 \pm 0.05$ |
| L (mm) | $1.00 \pm 0.10$ | $2.00 \pm 0.10$ | $1.60 \pm 0.10$ | $3.20 \pm 0.15$ |
| $\mathrm{~T}(\mathrm{~mm})$ | $0.30 \pm 0.10$ | $0.45 \pm 0.10$ | $0.40 \pm 0.10$ | $0.60 \pm 0.10$ |
| $\mathrm{~W}_{1}(\mathrm{~mm})$ | $0.25 \pm 0.10$ | $0.30 \pm 0.15$ | $0.30 \pm 0.10$ | $0.30 \pm 0.15$ |
| $\mathrm{~W}_{2}(\mathrm{~mm})$ | $1.00 \pm 0.10$ | $1.00 \pm 0.10$ | $1.60 \pm 0.10$ | $1.60 \pm 0.15$ |

For dimension, please refer to Table


Fig. 5 AFI22/I24/I62/164 series chip resistors dimension

SCHEMAJIC
For dimension, please refer to Fig. 5 and Table I

## ELETRJCAL CHARACTERISTJCS

Table 2

| CHARACTERISTICS | AFI22 | AFI24 | AFI 62 |  | AFI64 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Operating Temperature | $-50^{\circ} \mathrm{C}$ to $+155^{\circ} \mathrm{C}$ | $-55{ }^{\circ} \mathrm{C}$ to $+155{ }^{\circ} \mathrm{C}$ | $-55^{\circ} \mathrm{C}$ to | $155^{\circ} \mathrm{C}$ | $-55{ }^{\circ} \mathrm{C}$ to $+155^{\circ} \mathrm{C}$ |
| Rated Power | $1 / 16 \mathrm{~W}$ | $1 / 16 \mathrm{~W}$ |  | 1/16W | 1/16W |
| Maximum Working Voltage | 50 V | 25 V |  | 50 V | 50V |
| Maximum Overload Voltage | 100 V | 50 V |  | I OOV | 100 V |
| Dielectric Withstanding | 100 V | 100 V |  | I00V | I00V |
| Resistance Range | $\begin{array}{r} 5 \% \text { (E24) I } \Omega \text { to } I \mathrm{M} \Omega \\ 1 \% \text { (E24/E96) } 10 \Omega \text { to } \mathrm{I} \Omega \\ \text { Jumper < } 50 \mathrm{~m} \Omega \end{array}$ | $\begin{array}{r} 5 \% \text { (E24) I } \Omega \text { to I } \mathrm{M} \Omega \\ \text { I\% (E24/E96) I } \Omega \text { to I } \mathrm{M} \Omega \\ \text { Jumper }<50 \mathrm{~m} \Omega \end{array}$ | $\begin{array}{r} 5 \% \text { (E24) I } \Omega \\ \text { I\% (E24/E96) I } \Omega \\ \text { Jumper } \end{array}$ | $\begin{aligned} & =1 \mathrm{M} \Omega \\ & =1 \mathrm{M} \Omega \\ & =50 \mathrm{~m} \Omega \end{aligned}$ | $\begin{array}{r} 5 \% \text { (E24) I } \Omega \text { to } \mathrm{I} \mathrm{M} \Omega \\ \% \text { (E24/E96) I } \Omega \text { to I } \mathrm{M} \Omega \\ \text { Jumper < } 50 \mathrm{~m} \Omega \end{array}$ |
| Temperature Coefficient |  | $\begin{aligned} & \Omega \leq R \leq 10 \Omega \pm 250 \mathrm{ppm} /{ }^{\circ} \mathrm{C} \\ & \Omega \leq R \leq 1 \mathrm{M} \Omega \pm 200 \mathrm{ppm} /{ }^{\circ} \mathrm{C} \end{aligned}$ |  |  | $\pm 250 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |
| Jumper Criteria | Rated Current 0.5 A <br> Maximum Current 1.0 A | $\begin{array}{rr} \text { Rated Current } & 1.0 \mathrm{~A} \\ \text { Maximum Current } & 2.0 \mathrm{~A} \end{array}$ | Rated Current <br> Maximum Current | 1.0 A 2.0 A | Rated Current I.0A <br> Maximum Current 2.0A |

## POOTPRINT AND SOLDERING PROFULES

For recommended footprint and soldering profiles, please refer to data sheet "Chip resistors mounting".

## PACKING STYLE AND PACKAGING QUANTITY

| PACKING STYLE | REEL DIMENSION | AFI22 | AFI24 | AFI62 | AFI64 |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Paper Taping Reel (R) | 7" (178 mm) | 10,000 units | 10,000 units | 5,000 units | 5,000 units |
|  | 13 " $(330 \mathrm{~mm})$ | 50,000 units | 40,000 units | --- | 20,000 units |

## NOTE

I. For paper tape and reel specification/dimensions, please refer to data sheet "Chip resistors packing".

## FUNCTIONAL DESCRIPTION

## POWER RATING

AFI22 / AFI24 / AFI62 / AFI64 rated power at $70^{\circ} \mathrm{C}$ is $1 / 16 \mathrm{~W}$

## RATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:
$V=\sqrt{(P \times R)}$
or max. working voltage whichever is less
Where
$\mathrm{V}=$ Continuous rated DC or


Fig. 7 Maximum dissipation (P) in percentage of rated power as a function of the operating ambient temperature ( $\mathrm{T}_{\mathrm{amb}}$ ) AC (rms) working voltage (V)
$\mathrm{P}=$ Rated power (W)
$R=$ Resistance value ( $\Omega$ )

## TESTS AND REGUIREMENTS

Table 4 Test condition, procedure and requirements

| TEST | TEST METHOD | PROCEDURE | REQUIREMENTS |
| :--- | :--- | :--- | :--- | :--- |
| Life/ | MIL-STD-202-method 108 | 1,000 hours at $70 \pm 2^{\circ} \mathrm{C}$ applied RCWV | $\pm(2 \%+0.05 \Omega)$ |
| Endurance | IEC $60 \mid 15-14.25$ | 1.5 hours on, 0.5 hour off, still air required | $<100 \mathrm{~m} \Omega$ for Jumper |


| High Temperature | MIL-STD-202-method 108 | 1,000 hours at maximum operating <br> temperature depending on specification, <br> Exposure | $\pm(1 \%+0.05 \Omega)$ <br>  <br>  |
| :--- | :--- | :--- | :--- |
|  | Tolerances: $155 \pm 3^{\circ} \mathrm{C}$ | $<50 \mathrm{~m} \Omega$ for Jumper |  |


| Moisture <br> Resistance | MIL-STD-202-method I06 | Each temperature / humidity cycle is defined at | $\pm(2 \%+0.05 \Omega)$ |
| :---: | :---: | :---: | :---: |
|  |  | 8 hours (method 106G), 3 cycles / 24 hours for IOd with $25^{\circ} \mathrm{C} / 65^{\circ} \mathrm{C} 95 \%$ R.H, without steps $7 \mathrm{a} \& 7 \mathrm{~b}$, unpowered | $<100 \mathrm{~m} \Omega$ for Jumper |
|  |  | Parts mounted on test-boards, without condensation on parts |  |
|  |  | Measurement at $24 \pm 2$ hours after test conclusion |  |
| Thermal Shock | MIL-STD-202-method 107 | $-55 /+125^{\circ} \mathrm{C}$ | $\pm(1 \%+0.05 \Omega)$ |
|  |  | Note: Number of cycles required is 300 . Devices mounted | $<50 \mathrm{~m} \Omega$ for Jumper |
|  |  | Maximum transfer time is 20 seconds. Dwell time is 15 minutes. Air - Air |  |
| Short Time Overload | IEC60\|I5-| 4.13 | 2.5 times RCWV or maximum overload voltage whichever is less for 5 sec at room temperature | $\pm(2 \%+0.05 \Omega)$ |
|  |  |  | < $50 \mathrm{~m} \Omega$ for Jumper |
|  |  |  | No visible damage |
| Board Flex/ <br> Bending | IEC60\| | 5 -| 4.33 | Device mounted on PCB test board as described, only I board bending required 3 mm bending | $\pm(1 \%+0.05 \Omega)$ |
|  |  |  | $<50 \mathrm{~m} \Omega$ for Jumper |
|  |  |  | No visible damage |
|  |  | Bending time: $60 \pm 5$ seconds |  |
|  |  | Ohmic value checked during bending |  |

$\qquad$

| TEST | TEST METHOD | PROCEDURE | REQUIREMENTS |
| :---: | :---: | :---: | :---: |
| Solderability |  |  |  |
| - Wetting | J-STD-002 test B | Electrical Test not required | Well tinned ( $\geq 95 \%$ covered) |
|  |  | Magnification 50X | No visible damage |
|  |  | SMD conditions: |  |
|  |  | ${ }^{\text {st }}$ step: method B , aging 4 hours at $155^{\circ} \mathrm{C}$ dry heat |  |
|  |  | $2^{\text {nd }}$ step: leadfree solder bath at $245 \pm 3^{\circ} \mathrm{C}$ |  |
|  |  | Dipping time: $3 \pm 0.5$ seconds |  |
| - Leaching | J-STD-002 test D | Leadfree solder, $260^{\circ} \mathrm{C}, 30$ seconds immersion time | No visible damage |
| - Resistance to Soldering Heat | IEC 60115-1 4.18 | Condition B, no pre-heat of samples | $\pm(1 \%+0.05 \Omega)$ |
|  | MIL-STD-202 Method 215 | Leadfree solder, $260^{\circ} \mathrm{C}, 10$ seconds | $<50 \mathrm{~m} \Omega$ for Jumper |
|  |  | immersion time | No visible damage |
|  |  | Procedure 2 for SMD: devices fluxed and cleaned with isopropanol |  |
| FOS | ASTM-B-809-95* | Sulfur 750 hours, $105^{\circ} \mathrm{C}$, unpowered | $\pm(4.0 \%+0.05 \Omega)$ |
|  | *Modified |  | $<100 \mathrm{~m} \Omega$ for Jumper |


| REVISION | DATE | CHANGE NOTIFICATION | DESCRIPTION |
| :---: | :---: | :---: | :---: |
| Version 5 | Mar. 20, 2017 | - | - Modify AFI24/164 Equivalent Circuit Diagram |
| Version 4 | Jun. 23, 2016 | - | - AEC-Q200 qualified |
| Version 3 | Nov. 17, 2015 | - | - Add in AFI 62 |
| Version 2 | May 29,2015 | - | - Add in AFI 64 |
| Version I | Aug. 15, 2014 | - | - Update AFI24 dimensions |
| Version 0 | Oct. 02, 2013 | - | - First issue of this specification |

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